Copper Disk Single Crystal - T 1.5mm Ø 5mm

Formula: Cu
Percentage Purity: 99.999%
Thickness: 1.5mm
Diameter: 5mm
Orientation: -100
Orientation Accuracy: = 1°
Polish: Polished
Surface Finish: = 0.03µm Ra
CAS Number: 7440-50-8
UOM Code: 275-075-16
Legacy Code: CU002074
Distributor Code: GF27507516
SKU: 1000081104
Product Code: CU00-SC-000271

Material Properties for Metals

Atomic Properties

Element	Value
Atomic number	29
Crystal structure	Face centred cubic
Electronic structure	Ar $3d^{1}$? $4s^{1}$
Valences shown	1, 2
Atomic weight(amu)	63.546
Thermal neutron absorption cross-section(Barns)	3.8
Photo-electric work function(eV)	4.5
Natural isotope distribution(Mass No./%)	65/ 30.8
Natural isotope distribution(Mass No./%)	63/ 69.2
Atomic radius - Goldschmidt(nm)	0.128
Ionisation potential(No./eV)	4/ 55.2
Ionisation potential(No./eV)	6/ 103
Ionisation potential(No./eV)	1/ 7.73
Ionisation potential(No./eV)	5/ 79.9
Ionisation potential(No./eV)	3/ 36.8
Ionisation potential(No./eV)	2/ 20.29

Mechanical Properties

Element	Value
Material condition	Soft
Material condition	Hard
Poisson's ratio	0.343
Poisson's ratio	0.343
Bulk modulus(GPa)	137.8
Bulk modulus(GPa)	137.8
Tensile modulus(GPa)	129.8
Tensile modulus(GPa)	129.8
Izod toughness(J m?¹)	68
Izod toughness(J m?¹)	58
Hardness - Vickers(kgf mm?²)	87
Hardness - Vickers(kgf mm?²)	49
Tensile strength(MPa)	314
Tensile strength(MPa)	224
Yield strength(MPa)	270
Yield strength(MPa)	54

Electrical Properties

Element	Value
Electrical resistivity(µOhmcm)	1.69@20°C
Temperature coefficient(K?¹)	0.0043@0-100°C
Thermal emf against Pt (cold 0C - hot 100C)(mV)	0.76

Physical Properties

Element	Value
Boiling point(C)	2567
Density(gcm?³)	8.96@20°C

Thermal Properties

Element	Value
Melting point(C)	1083
Latent heat of evaporation(J g?¹)	4796
Latent heat of fusion(J g?¹)	205
Specific heat(J K?¹ kg?¹)	385@25°C
Thermal conductivity(W m?¹ K?¹)	401@0-100°C
Coefficient of thermal expansion(x10?? K?¹)	17@0-100°C